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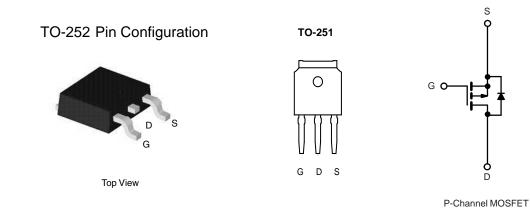
## P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	
- 30	0.0052 at V <sub>GS</sub> = - 10 V	-85	
	0.007 at $V_{GS}$ = - 4.5 V	-80	

#### **FEATURES**

Compliant to RoHS Directive 2002/95/EC





<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)					
Parameter	Symbol	Limit	Unit		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C		- 85 <sup>a</sup>	А	
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	- 68		
Pulsed Drain Current	I <sub>DM</sub>	- 260	A		
Avalanche Current	I <sub>AR</sub>	- 67			
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	186	mJ	
Pawar Dissinction	T <sub>C</sub> = 25 °C (TO-220AB and TO-263)	D	187 <sup>d</sup>	w	
Power Dissipation	T <sub>A</sub> = 25 °C (TO-263) <sup>c</sup>	P <sub>D</sub>	3.75	vv	
Operating Junction and Storage Tempera	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-251) <sup>c</sup>	Р	40	°C/W	
	Free Air (TO-252)	R <sub>thJA</sub>	62.5		
Junction-to-Case	·	R <sub>thJC</sub>	0.8		

Notes:

a. Package limited.

b. Duty cycle  $\leq$  1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 30			- V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 24 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA	
		$V_{DS} = -24 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			- 250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 30 A		0.0052	0.0063		
Drain-Source On-State Resistance <sup>a</sup>	Б	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 125 °C			0.0095	0	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 175 °C			0.0126	Ω	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 20 A		0.007	0.010		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 30 A	20			S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1089		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = -15 V, f = 1 MHz$		759			
Reversen Transfer Capacitance	C <sub>rss</sub>			419			
Total Gate Charge <sup>c</sup>	Qg			130	280		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -30 \text{ A}$		62		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			39			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			30			
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_{L}$ = 0.2 $\Omega$		268			
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 30 Å, $V_{GEN}$ = - 10 V, $R_g$ = 2.5 $\Omega$		150		ns	
Fall Time <sup>c</sup>	t <sub>f</sub>			210			
Source-Drain Diode Ratings and Cha	racteristics <sup>b</sup>	(T <sub>C</sub> = 25 °C)					
Continuous Current	۱ <sub>S</sub>				- 85	٨	
Pulsed Current	I <sub>SM</sub>				- 260	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 1 A, V <sub>GS</sub> = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			55	100	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = - 30 A, dl/dt = 100 A/μs		2.5	5	Α	
Reverse Recovery Charge	Q <sub>rr</sub>	<u></u>		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

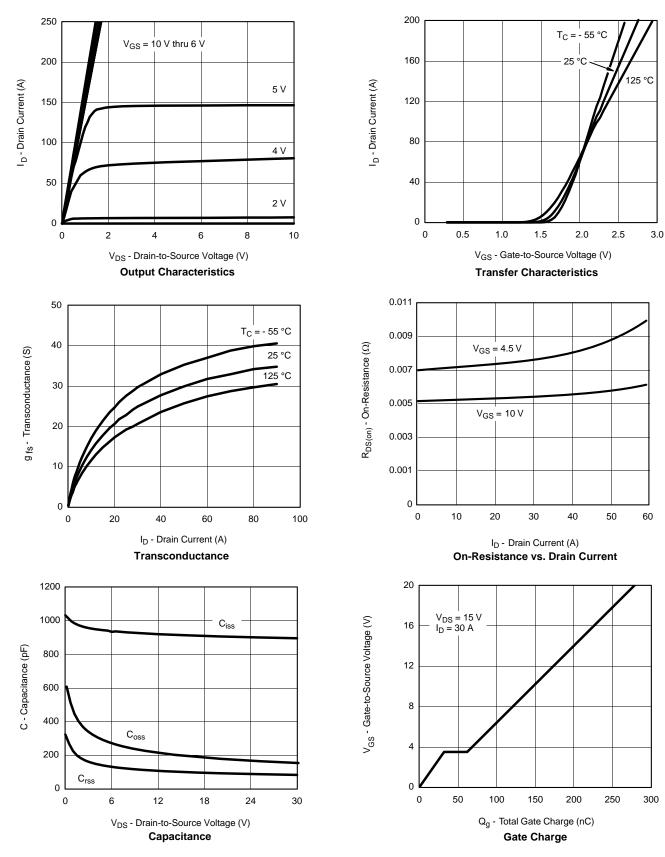
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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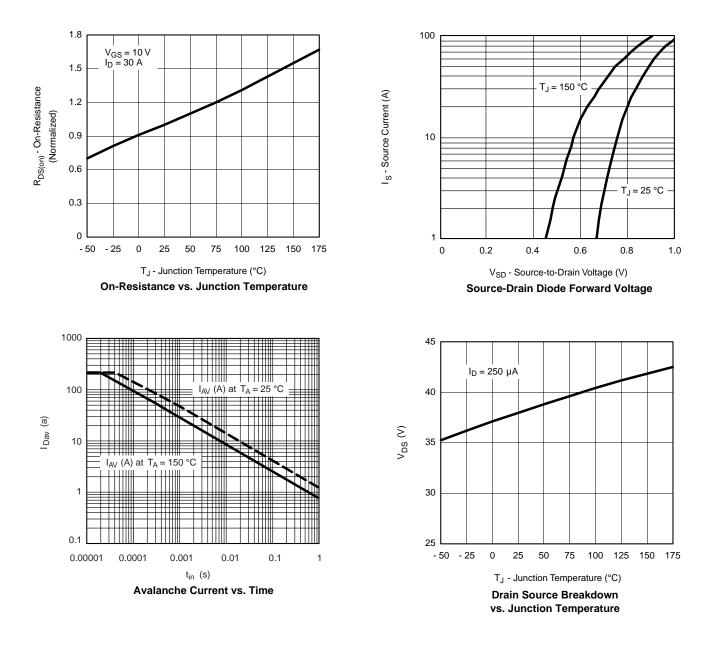






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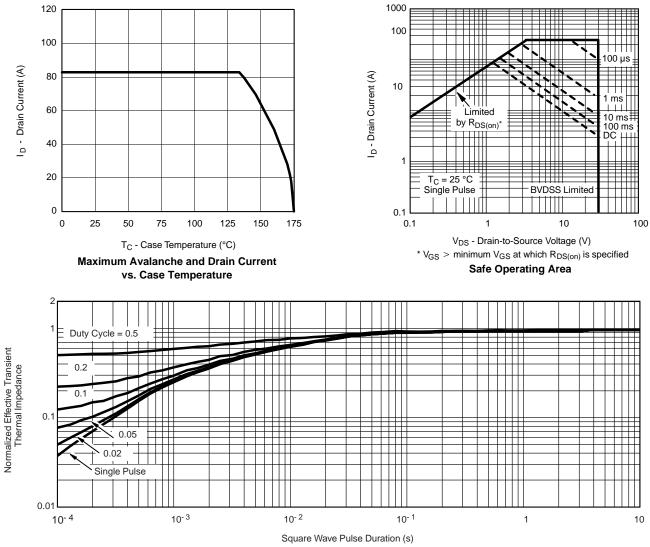
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





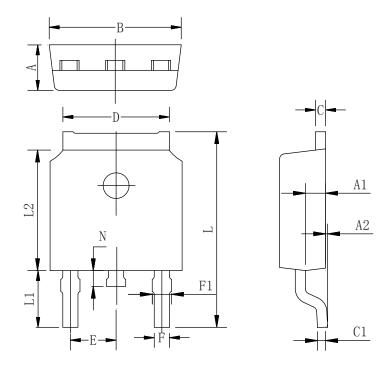
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#### **THERMAL RATINGS**



Normalized Thermal Transient Impedance, Junction-to-Case

# TO-252-2L PACKAGE OUTLINE

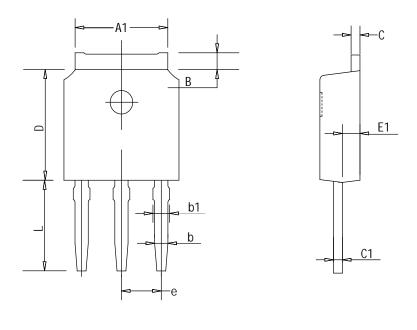


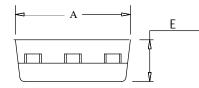
#### COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max	
А	2.10	2.30	2.50	
A1	0.88	1.01	1.16	
A2	0.00	0.15	0.28	
В	6.40	6.60	6.80	
С	0.42	0.50	0.63	
C1	0.42	0.50	0.63	
D	5.08	5.32	5.65	
Е	2.286 TYP			
F	0.63	0.76	0.89	
F1	0.64	0.86	1.08	
L	9.30	9.90	10.80	
L1	2.4	2.8	3.6	
L2	5.90	6.10	6.55	
N	0.57	0.80	1.05	



# TO-251 PACKAGE OUTLINE





#### COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
А	6.30	6.60	6.90
A1	5.00	5.30	5.60
В	0.80	1.00	1.20
С	0.40	0.50	0.60
C1	0.40	0.50	0.60
D	5.80	6.10	6.40
E	2.10	2.30	2.50
E1	0.80	1.00	1.20
L	4.50	5.00	5.50
e	2.10	2.30	2.50
b	0.66	0.76	0.86
b1	0.66	0.86	1.06

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